	terial Composit opyright 2005. IPC, 1 national and Pan-An	Bannockb	urn, Illinois. A	ll rights reserved untions.	under both	This docume level parts, t	ent is a decla he declaratio	tration of	the substance the substance appasses all low	es within ver level	the manufactu materials for w	rer listed it which the m	tem. No nanufact	te: if the turer has	item is an ass engineering re	embly with lowe esponsibility.
	IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				e *	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					ials and M	als and Mfg Information				
Supplier Information																
Company name*			Company unique ID			Unique ID Authority					Respons	Response Date*				
onsemi												2025-07	2025-07-09			
Contact Name			Title - Contact				Phone - Contact*					Email -	Email - Contact*			
Product-Env-Stewards			Product Enviro Compliance			NA					Product-Env-Stewards@onsemi.com					
Authorized Representative*			Title - Representative			Phone - Representative*				Email - Representative*						
Product-Env-Stewards			Product Enviro Compliance				NA				Produc	Product-Env-Stewards@onsemi.com				
Requester Item	Requester Item Number Mfr Iter		Number Mfr Item Name				Effective D	late Ve	ersion	Manufacturing Site			Weight*	¢	UOM	Unit Type
	CAT809N		MTBI-GT3	BI-GT3 SUP, PUSH-PULL, ACT LOW			2025-07-09)		ТНВ		-	14.1		mg	Each
Manufacturing Proce	ess Information	l					·									
Terminal Plating / Grid Array Material		d T	erminal Base Alloy J-S		J-STD-020 MS	MSL Rating		Peak Process Body Temperat		ture Max Time at Peak T		Temperat	Temperature Number		f Reflow Cycl	es
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)			CU Alloy 1		1		260		C	30	30 seco		conds 3			
Comments												•				
evel 1 - maximum time at j	peak temperature d	uring sol	dering is 10-3	0 seconds												
For more information rega	rding material com	position	please refer to	page 3												

RoHS Material Composition Declaration				Declaration Type *	Detailed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	(Pb), Mercury (Hg), Hexavalent Chror	HS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl halate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of							
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all							
Exemption List Version	EL-2011/534/EU											
Declaration Signature												
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.												
Supplier Digital Signature Ra	stislav Drska	Le										

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.15	mg	Supplier	Silicon (Si)	7440-21-3		0.15	mg
Die Attach	1.0E-4	mg		Epoxy resin	proprietary data		0	mg
			Supplier	Fatty acids, C18-unsatd., dimers, polymers with epichlorhydrin	68475-94-5		0	mg
			Supplier	2,2'-[[2-(oxiranylmethoxy)-1,3- phenylene]bis(methylene)]bisoxirane	13561-08-5		0	mg
			Supplier	4-Methyl-2-Phenyl-1H-Imidazole	827-43-0		0	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0	mg
Lead Frame	0.7943	mg	Supplier	Zinc (Zn)	7440-66-6		0.001	mg
			Supplier	Iron (Fe)	7439-89-6		0.0187	mg
			Supplier	Copper (Cu)	7440-50-8		0.7744	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0002	mg
Mold Compound-Black	13.11	mg		Epoxy resin	proprietary data		0.6555	mg
			Supplier	Phenolic Resin	Proprietary Data		0.2622	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.3277	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0655	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		11.799	mg
Plating	0.008	mg	Supplier	Palladium (Pd)	7440-05-3		0.0003	mg
			В	Nickel (Ni)	7440-02-0		0.0076	mg
			Supplier	Gold (Au)	7440-57-5		0	mg
Wire Bond - Au	0.0376	mg	Supplier	Gold (Au)	7440-57-5		0.0376	mg